

IN THE CLAIMS

Claims 1-28 (cancelled)

21 (29) (currently amended) A method for forming a container capacitor, comprising the steps of: (figs. 17 or 18).

providing a cup-shaped bottom electrode;
providing an insulating layer around and in contact with an exterior surface of said cup-shaped bottom electrode;

masking a first partial circumferential portion of said insulating layer;

etching a second partial circumferential portion of said insulating layer from a partial circumferential part of said exterior surface to expose the part of said exterior surface;

depositing a dielectric layer on said part of said exterior surface; and

depositing a conductive layer on said dielectric layer.

22 (67) (previously amended) A method for forming a container capacitor comprising:

fabricating a cup-shaped bottom electrode;

providing an insulating layer around an exterior surface of the cup-shaped bottom electrode, such that an entire vertical height of the exterior surface is in contact with the insulating layer;

masking a first portion of the insulating layer;

etching a second portion of the insulating layer from a first region of the exterior surface to expose the first region of the exterior surface, such that the insulating layer remains in contact with an entire vertical height of a remaining region of the exterior surface;

depositing a dielectric layer on the first region of the exterior surface; and depositing a conductive layer on the dielectric layer.

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[6159818] M 6608392 (D)
[633240] M 6693519 (D)
[6159818] M 6528834 (D)
[6281091] M 6591735 (D)
[6329263] M 6661051 (D)
[09/653447] M → o.gionj
10/138458 M → o.gionj